

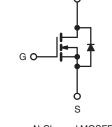
Vishay Siliconix



Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	100			
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.27		
Q _g (Max.) (nC)	16			
Q _{gs} (nC)	4.4			
Q _{gd} (nC)	7.7			
Configuration	Single			





N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- 175 °C Operating Temperature
- Fast Switching
- · Ease of Paralleling
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-free	IRFD120PbF
	SiHFD120-E3
SnPb	IRFD120
	SiHFD120

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \degree C$, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage		V _{DS}	100	v		
Gate-Source Voltage	V _{GS}	± 20				
Continuous Drain Current	V_{GS} at 10 V $T_A = 25 \degree C$ $T_A = 100 \degree C$	- I _D	1.3			
	$T_A = 100 $ °C		0.94	А		
Pulsed Drain Current ^a	I _{DM}	10				
Linear Derating Factor		0.0083	W/°C			
Single Pulse Avalanche Energy ^b		E _{AS}	100	mJ		
Repetitive Avalanche Current ^a	I _{AR}	1.3	A			
Repetitive Avalanche Energy ^a	E _{AR}	0.13	mJ			
Maximum Power Dissipation	T _A = 25 °C	PD	1.3	W		
Peak Diode Recovery dV/dt ^c		dV/dt	5.5	V/ns		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 175	- °C		
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^d			

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 22 mH, R_g = 25 Ω , I_{AS} = 2.6 A (see fig. 12).

c. $I_{SD} \leq 9.2$ A, dl/dt ≤ 110 A/µs, $V_{DD} \leq V_{DS}, \, T_J \leq 175$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	120	°C/W

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$		100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Referen	ce to 25 °C, I _D = 1 mA	-	0.13	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS}	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 20 V$		-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	25	
		V _{DS} = 80 V	′, V _{GS} = 0 V, T _J = 150 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}$	I _D = 0.78 A ^b	-	-	0.27	Ω
Forward Transconductance	g _{fs}	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 0.78 \text{ A}^{b}$		0.80	-	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 V$ $V_{DS} = 25 V$ f = 1.0 MHz, see fig. 5		-	360	-	pF
Output Capacitance	Coss			-	150	-	
Reverse Transfer Capacitance	C _{rss}			-	34	-	
Total Gate Charge	Qg		I _D = 9.2 A, V _{DS} = 80 V see fig. 6 and 13 ^b	-	-	16	nC
Gate-Source Charge	Q_gs	$V_{GS} = 10 V$		-	-	4.4	
Gate-Drain Charge	Q _{gd}			-	-	7.7	
Turn-On Delay Time	t _{d(on)}			-	6.8	-	
Rise Time	t _r	Voo	V _{DD} = 50 V, I _D = 9.2 A		27	-	- ns
Turn-Off Delay Time	t _{d(off)}	$R_{g} = 18 \Omega, R_{D} = 5.2 \Omega, \text{ see fig. } 10^{b}$		-	18	-	
Fall Time	t _f			-	17	-	
Internal Drain Inductance	L _D	6 mm (0.25") f	Between lead, 6 mm (0.25") from		4.0	-	54
Internal Source Inductance	L _S	die contact		-	6.0	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	1.3	A
Pulsed Diode Forward Current ^a	I _{SM}			-	-	10	
Body Diode Voltage	V _{SD}	$T_{J} = 25 \text{ °C}, I_{S} = 1.3 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	2.5	V
Body Diode Reverse Recovery Time	t _{rr}	- T _J = 25 °C, I _F = 9.2 A, dl/dt = 100 A/μs ^b		-	130	260	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.65	1.3	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L				L _D)	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



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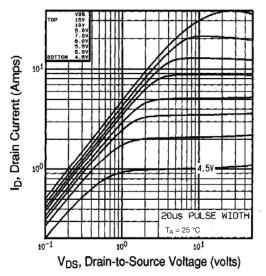


Fig. 1 - Typical Output Characteristics, $T_A = 25 \ ^\circ C$

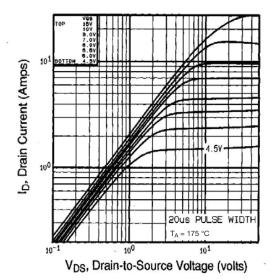
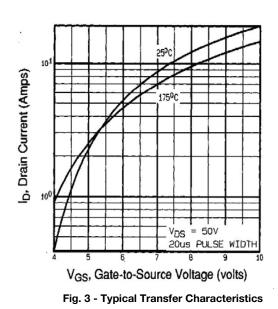


Fig. 2 - Typical Output Characteristics, $T_A = 175 \ ^\circ C$



 (v_{OS}) (v_{OS})

Fig. 4 - Normalized On-Resistance vs. Temperature

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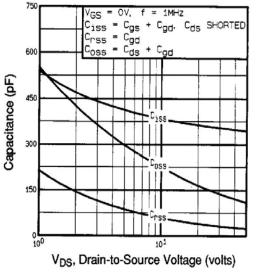
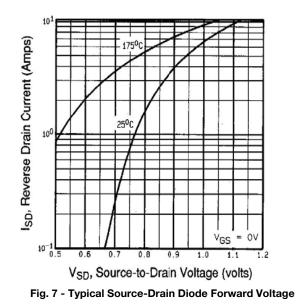
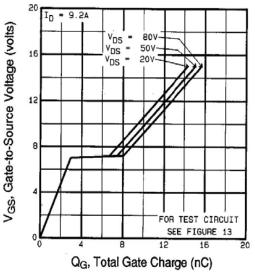
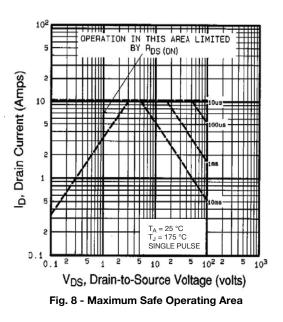


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage











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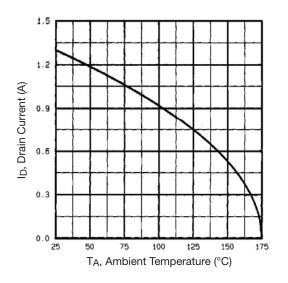


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

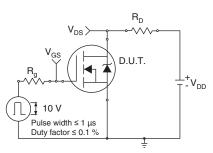


Fig. 10a - Switching Time Test Circuit

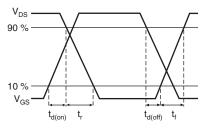


Fig. 10b - Switching Time Waveforms

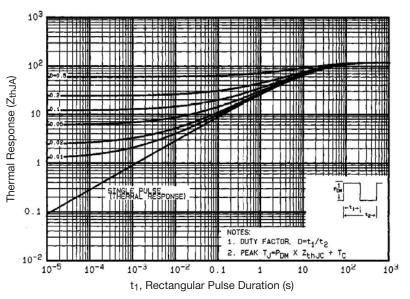


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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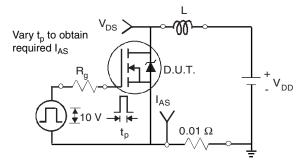


Fig. 12a - Unclamped Inductive Test Circuit

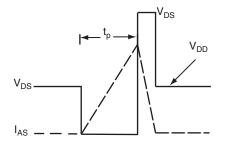


Fig. 12b - Unclamped Inductive Waveforms

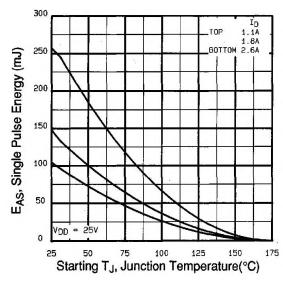


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

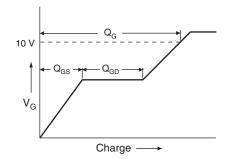


Fig. 13a - Basic Gate Charge Waveform

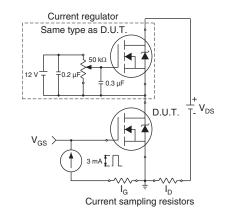
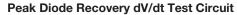
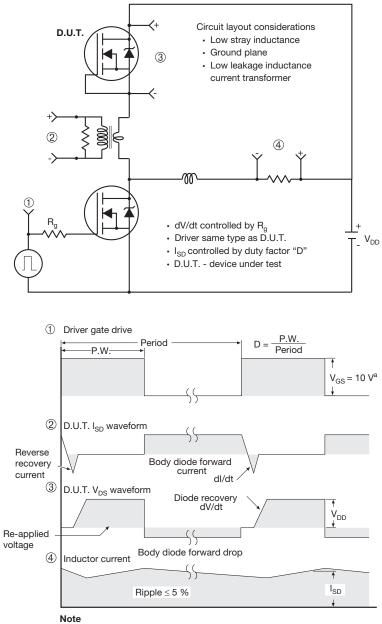


Fig. 13b - Gate Charge Test Circuit



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a. $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

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